LMC7221 Tiny CMOS Comparator with Rail-To-Rail Input and Open Drain Output

Check for Samples: LMC7221

FEATURES

- **Tiny 5-Pin SOT23 package saves space**
- **Package is less than 1.43 mm thick**
- **Guaranteed specs at 2.7V, 5V, 15V supplies**
- **Typical supply current 7 µA at 5V**
- **Response time of 4 µs at 5V**
- **LMC7221—open drain output**
- **Input common-mode range beyond V^- and V^+**
- **Low input current**

APPLICATIONS

- **Mixed voltage battery powered products**
- **Notebooks and PDAs**
- **PCMCIA cards**
- **Mobile communications**
- **Alarm and security circuits**
- **Driving low current LEDs**
- **Direct sensor interface**

DESCRIPTION

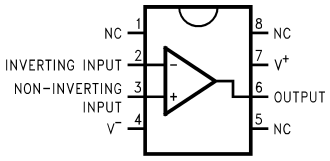
The LM7221 is a micropower CMOS comparator available in the space saving 5-Pin SOT23 package. This makes this comparator ideal for space and weight critical designs. The LMC7221 is also available in the 8-Pin SOIC package. The LMC7221 is supplied in two offset voltage grades, 5 mV and 15 mV.

The open drain output can be pulled up with a resistor to a voltage which can be higher or lower than the supply voltage—this makes the part useful for mixed voltage systems.

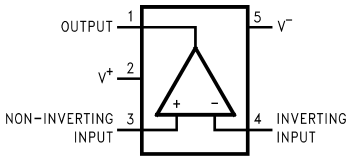
For a tiny comparator with a push-pull output, please see the LMC7211 datasheet.

Connection Diagram

8-Pin SOIC



5-Pin SOT23



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings (1)

ESD Tolerance (2)	2 kV
Differential Input Voltage	V^+ +0.3V, V^- −0.3V
Voltage at Input	V^+ +0.3V, V^- −0.3V
Voltage at Output Pin	15V
Supply Voltage (V^+–V^-)	16V
Current at Input Pin (3)	±5 mA
Current at Output Pin (4) (5)	±30 mA
Current at Power Supply Pin	40 mA
Lead Temperature (soldering, 10 sec.)	260°C
Junction Temperature (6)	150°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.
(2) Human Body Model, applicable std. MIL-STD-883, Method 3015.7. Machine Model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC)Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC).
(3) All limits are guaranteed by testing or statistical analysis.
(4) Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of ±30 mA may adversely affect reliability.
(5) Limiting input pin current is only necessary for input voltages which exceed the absolute maximum input voltage rating.
(6) The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA}. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} – T_A)/ \theta_{JA}$. All numbers apply for packages soldered directly onto a PC Board.

Operating Ratings (1)

Supply Voltage	$2.7 \le V_{CC} \le 15V$
Temperature Range (2)	
LMC7221AI, LMC7221BI	−40°C to +85°C
Thermal Resistance (θ_{JA})	
8-Pin SOIC	180°C/W
5-Pin SOT23	325°C/W

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.
(2) The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA}. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} – T_A)/ \theta_{JA}$. All numbers apply for packages soldered directly onto a PC Board.

2.7V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for T_J = 25°C, V^+ = 2.7V, V^- = 0V, $V_{CM} = V_O = V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ(1)	LMC7221AI Limit(2)	LMC7221BI Limit(2)	Units
V_{OS}	Input Offset Voltage		3	5	15	mV
				8	**18**	max
TCV_{OS}	Input Offset Voltage Temperature Drift		1.0			µV/°C
	Input Offset Voltage Average Drift	(3)	3.3			µV/Month
I_B	Input Current		0.04			pA
I_{OS}	Input Offset Current		0.02			pA
CMRR	Common Mode Rejection Ratio	$0V \le V_{CM} \le 2.7V$	75			dB

(1) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.
(2) All limits are guaranteed by testing or statistical analysis.
(3) C_L includes the probe and test jig capacitance.

2.7V Electrical Characteristics (continued)

Unless otherwise specified, all limits guaranteed for T_J = 25°C, V^+ = 2.7V, V^- = 0V, $V_{CM} = V_O = V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ(1)	LMC7221AI Limit(2)	LMC7221BI Limit(2)	Units
PSRR	Power Supply Rejection Ratio	2.7V ≤ V^+ ≤ 15V	80			dB
A_V	Voltage Gain		100			dB
CMVR	Input Common-Mode Voltage Range	CMRR > 55 dB	3.0	2.9	2.9	V
				2.7	**2.7**	min
		CMRR > 55 dB	−0.3	−0.2	−0.2	V
				0.0	**0.0**	max
V_{OL}	Output Voltage Low	I_{LOAD} = 2.5 mA	0.2	0.3	0.3	V
				0.4	**0.4**	max
I_S	Supply Current	V_{OUT} = Low	7	12	12	µA
				14	**14**	max

5.0V and 15.0V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for T_J = 25°C, V^+ = 5.0V and 15V, V^- = 0V, $V_{CM} = V_O = V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ(1)	LMC7221AI Limit(2)	LMC7221BI Limit(2)	Units
V_{OS}	Input Offset Voltage		3	5	15	mV
				8	**18**	max
TCV_{OS}	Input Offset Voltage Temperature Drift	V^+ = 5V	1.0			µV/°C
		V^+ = 15V	4.0			
	Input Offset Voltage Average Drift	V^+ = 5V (3)	3.3			µV/Month
		V^+ = 15V (3)	4.0			
I_B	Input Current		0.04			pA
I_{OS}	Input Offset Current		0.02			pA
CMRR	Common Mode Rejection Ration	V^+ = 5.0V	75			dB
		V^+ = 15.0V	82			dB
PSRR	Power Supply Rejection Ratio	5V ≤ V^+ ≤ 10V	80			dB
A_V	Voltage Gain		100			dB
CMVR	Input Common-Mode Voltage Range	V^+ = 5.0V CMRR > 55 dB	5.3	5.2	5.2	V
				5.0	**5.0**	min
		V^+ = 5.0V CMRR > 55 dB	−0.3	−0.2	−0.2	V
				0.0	**0.0**	max
		V^+ = 15.0V CMRR > 55 dB	15.3	15.2	15.2	V
				15.0	**15.0**	min
		V^+ = 15.0V CMRR > 55 dB	−0.3	−0.2	−0.2	V
				0.0	**0.0**	max
V_{OL}	Output Voltage Low	V^+ = 5V I_{LOAD} = 5 mA	0.2	0.40	0.40	mV
				0.55	**0.55**	max
		V^+ = 15V I_{LOAD} = 5 mA	0.2	0.40	0.40	mV
				0.55	**0.55**	max

(1) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.
(2) All limits are guaranteed by testing or statistical analysis.
(3) C_L includes the probe and test jig capacitance.

5.0V and 15.0V Electrical Characteristics (continued)

Unless otherwise specified, all limits guaranteed for T_J = 25°C, V^+ = 5.0V and 15V, V^- = 0V, $V_{CM} = V_O = V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Typ (1)	LMC7221AI Limit (2)	LMC7221BI Limit (2)	Units
I_S	Supply Current	V_{OUT} = Low	7	14 **18**	14 **18**	µA max
I_{SC}	Short Circuit Current	Sinking (4)	45			mA

(4) Limiting input pin current is only necessary for input voltages which exceed the absolute maximum input voltage rating.

Leakage Characteristics

T_J = 25°C

Symbol	Parameter	Conditions	Typ (1)	LMC7221AI Limit (2)	LMC7221BI Limit (2)	Units
$I_{LEAKAGE}$	Output Leakage Current	V^+ = 2.7V $V_{IN}(+)$ = 0.5V $V_{IN}(-)$ = 0V V_{OUT} = 15V	0.1	500	500	nA

(1) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.
(2) All limits are guaranteed by testing or statistical analysis.

AC Electrical Characteristics

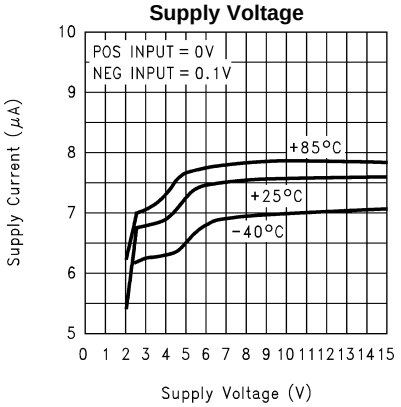
Unless otherwise specified, all limits guaranteed for T_J = 25°C, V^+ = 5V, V^- = 0V, $V_{CM} = V_O = V^+/2$. **Boldface** limits apply at the temperature extreme.

Symbol	Parameter	Conditions		Typ (1)	LMC7221AI Limit (2)	LMC7221BI Limit (2)	Units
t_{rise}	Rise Time	f = 10 kHz, C_L = 50 pF, (3) Overdrive = 10 mV, 5 kΩ Pullup		0.3			µs
t_{fall}	Fall Time	f = 10 kHz, C_L = 50 pF, (3) Overdrive = 10 mV, 5 kΩ Pullup		0.3			µs
t_{PHL}	Propagation Delay (High to Low) (4)	f = 10 kHz, C_L = 50 pF, 5 kΩ Pullup (3)	10 mV	10			µs
			100 mV	4			
		V^+ = 2.7V, f = 10 kHz, C_L = 50 pF, 5 kΩ Pullup (3)	10 mV	10			µs
			100 mV	4			
t_{PLH}	Propagation Delay (Low to High) (4)	f = 10 kHz, C_L = 50 pF, 5 kΩ Pullup (3)	10 mV	6			µs
			100 mV	4			
		V^+ = 2.7V, f = 10 kHz, C_L = 50 pF, 5 kΩ Pullup (3)	10 mV	7			µs
			100 mV	4			

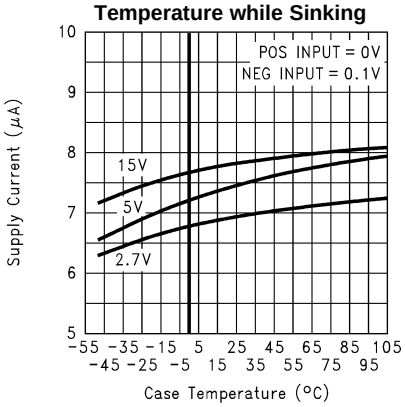
(1) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.
(2) All limits are guaranteed by testing or statistical analysis.
(3) Do not short circuit the output to V^+ when V^+ is greater than 12V or reliability will be adversely affected.
(4) Input offset voltage average drift is calculated by dividing the accelerated operating life V_{OS} drift by the equivalent operational time. This represents worst case input conditions and includes the first 30 days of drift.

Typical Performance Characteristics

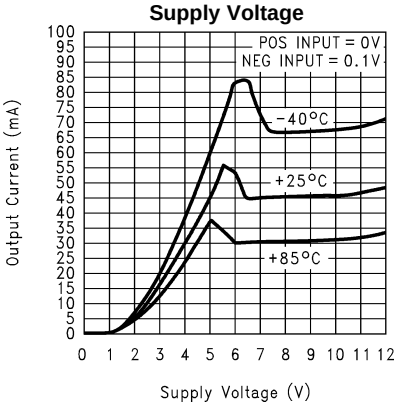
Supply Current vs. Supply Voltage



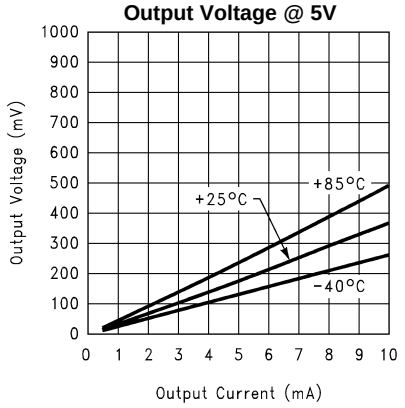
Supply Current vs. Temperature while Sinking



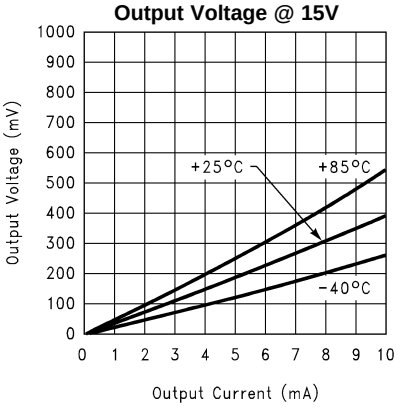
Output Sinking Current vs. Supply Voltage



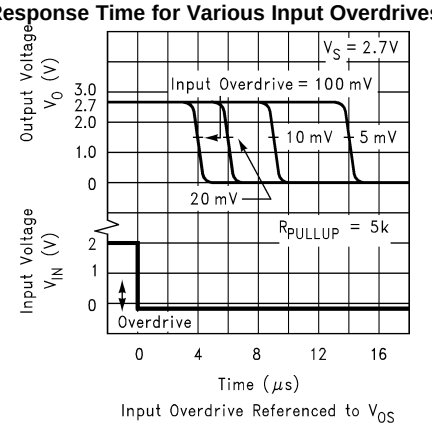
Output Sinking Current vs. Output Voltage @ 5V



Output Sinking Current vs. Output Voltage @ 15V

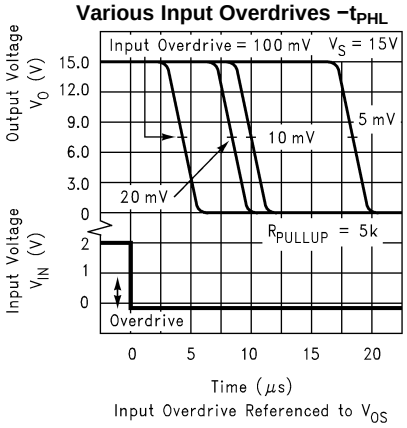


Response Time for Various Input Overdrives $-t_{PHL}$

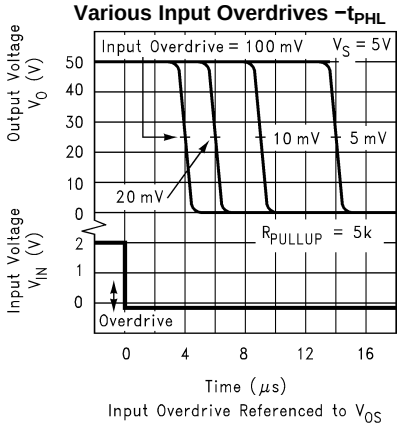


Typical Performance Characteristics (continued)

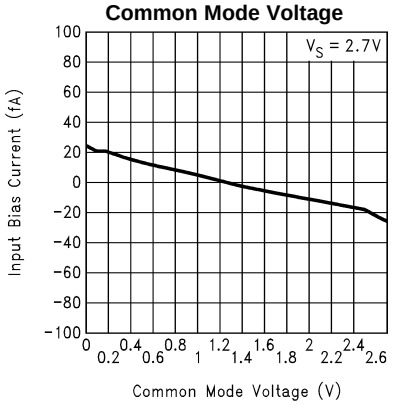
Response Time vs. Various Input Overdrives $-t_{PHL}$



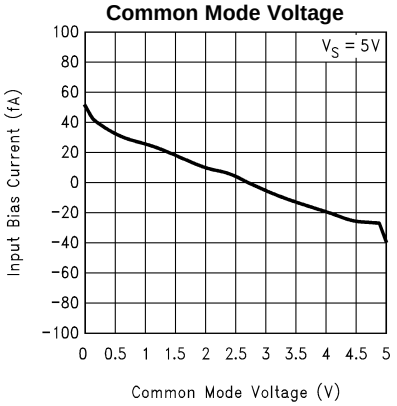
Response Time vs Various Input Overdrives $-t_{PHL}$



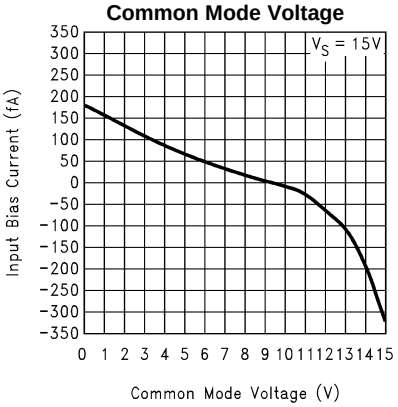
Input Bias Current vs. Common Mode Voltage



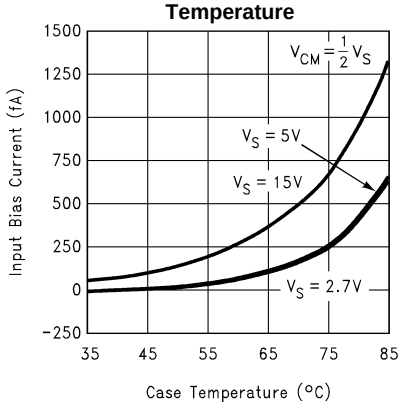
Input Bias Current vs. Common Mode Voltage



Input Bias Current vs. Common Mode Voltage

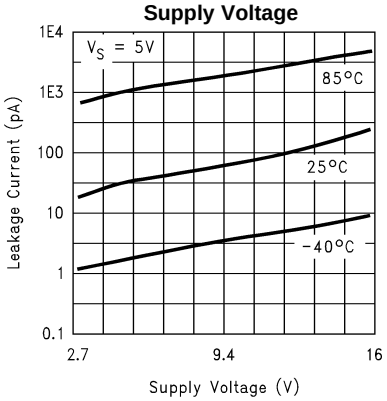


Input Bias Current vs. Temperature



Typical Performance Characteristics (continued)

Leakage Current vs. Supply Voltage



Application Information

BENEFITS OF THE LMC7221 TINY COMPARATOR

Size

The small footprint of the 5-Pin SOT23 packaged Tiny Comparator, (0.120 x 0.118 inches, 3.05 x 3.00 mm) saves space on printed circuit boards, and enable the design of smaller electronic products. Because they are easier to carry, many customers prefer smaller and lighter products.

Height

The height (0.056 inches, 1.43 mm) of the Tiny Comparator makes it possible to use it in PCMCIA type III cards.

Simplified Board Layout

The Tiny Comparator can simplify board layout in several ways. First, by placing a comparator where comparators are needed, instead of routing signals to a dual or quad device, long pc traces may be avoided.

By using multiple Tiny Comparators instead of duals or quads, complex signal routing and possibly crosstalk can be reduced.

Low Supply Current

The typical 7 µA supply current of the LMC7221 extends battery life in portable applications, and may allow the reduction of the size of batteries in some applications.

Wide Voltage Range

The LMC7221 is characterized at 15V, 5V and 2.7V. Performance data is provided at these popular voltages. This wide voltage range makes the LMC7221 a good choice for devices where the voltage may vary over the life of the batteries.

Digital Outputs Representing Signal Level

Comparators provide a high or low digital output depending on the voltage levels of the (+) and (−) inputs. This makes comparators useful for interfacing analog signals to microprocessors and other digital circuits. The LMC7221 can be thought of as a one-bit a/d converter.

Open Drain Output

The open drain output is like the open collector output of a logic gate. This makes the LMC7221 very useful for mixed voltage systems.

Driving LEDs (Light Emitting Diodes)

With a 5 volt power supply, the LMC7221's output sinking current can drive small, high efficiency LEDs for indicator and test point circuits. The small size of the Tiny package makes it easy to find space to add this feature to even compact designs.

Input range to Beyond Rail to Rail

The input common mode range of the LMC7221 is slightly larger than the actual power supply range. This wide input range means that the comparator can be used to sense signals close to the power supply rails. This wide input range can make design easier by eliminating voltage dividers, amplifiers, and other front end circuits previously used to match signals to the limited input range of earlier comparators. This is useful to power supply monitoring circuits which need to sense their own power supply, and compare it to a reference voltage which is close to the power supply voltage. The wide input range can also be useful for sensing the voltage drop across a current sense resistor for battery chargers.

Zero Crossing Detector

Since the LMC7221's common mode input range extends below ground even when powered by a single positive supply, it can be used with large input resistors as a zero crossing detector.

Low Input Currents and High Input Impedance

These characteristics allow the LMC7221 to be used to sense high impedance signals from sensors. They also make it possible to use the LMC7221 in timing circuits built with large value resistors. This can reduce the power dissipation of timing circuits. For very long timing circuits, using high value resistors can reduce the size and cost of large value capacitors for the same R-C time constant.

Direct Sensor Interfacing

The wide input voltage range and high impedance of the LMC7221 may make it possible to directly interface to a sensor without the use of amplifiers or bias circuits. In circuits with sensors which can produce outputs in the tens to hundreds of millivolts, the LMC7221 can compare the sensor signal with an appropriately small reference voltage. This may be done close to ground or the positive supply rail. Direct sensor interfacing may eliminate the need for an amplifier for the sensor signal. Eliminating the amplifier can save cost, space, and design time.

LOW VOLTAGE OPERATION

Comparators are the common devices by which analog signals interface with digital circuits. The LMC7221 has been designed to operate at supply voltages of 2.7V without sacrificing performance to meet the demands of 3V digital systems.

At supply voltages of 2.7V, the common-mode voltage range extends 200 mV (guaranteed) below the negative supply. This feature, in addition to the comparator being able to sense signals near the positive rail, is extremely useful in low voltage applications.

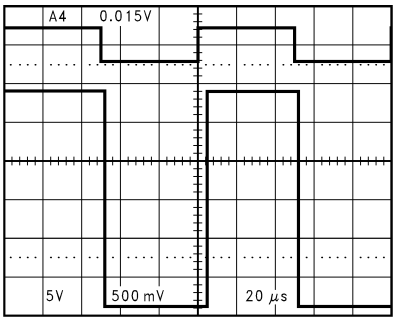


Figure 1. Even at Low-Supply Voltage of 2.7V, an Input Signal which Exceeds the Supply Voltages Produces No Phase Inversion at the Output

At V^+ = 2.7V propagation delays are t_{PLH} = 4 µs and t_{PHL} = 4 µs with overdrives of 100 mV.

Please refer to the performance curves for more extensive characterization.

OPEN DRAIN OUTPUT

Output Stage

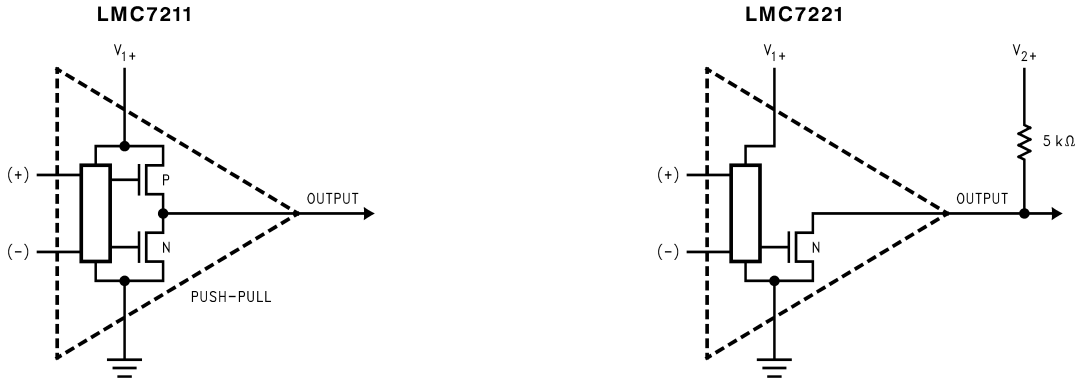


Figure 2. Output Stage

Figure 2 shows the difference between push-pull output and open drain output.

Push pull outputs will have a conventional high or low digital output, the same as a logic gate. Low will be the negative supply rail (usually ground) and high will be the positive supply rail.

This is useful if the chips you are interfacing to run on the same supply voltage as the comparator. An example would be an all +5V system.

Open drain outputs will only pull low—for the high output they depend on an external pull-up resistor. This can pull up to a voltage higher or lower than the comparator supply voltage. This voltage can be as high as 15V. This makes the open drain parts useful in mixed voltage systems. An example would be where the comparator runs at 5V and the logic circuits are at 3.3V. The pull-up resistor would go to the 3.3V supply.

Open drain outputs are the CMOS equivalent of open collector outputs.

OUTPUT SHORT CIRCUIT CURRENT

The LMC7221 has short circuit protection of 40 mA. However, it is not designed to withstand continuous short circuits, transient voltage or current spikes, or shorts to any voltage beyond the supplies. A resistor in series with the output should reduce the effect of shorts. For outputs which send signals off PC boards additional protection devices, such as diodes to the supply rails, and varistors may be used.

INPUT PROTECTION

If input signals are likely to exceed the common mode range of the LMC7221, or it is likely that signals may be present when power is off, damage to the LMC7221 may occur. Large value (100 kΩ to MΩ) input resistors may reduce the likelihood of damage by limiting the input currents. Since the LMC7221 has very low input leakage currents, the effect on accuracy will be small. Additional protection may require the use of diodes, as shown in *Figure 3*. Note that diode leakage current may affect accuracy during normal operation.

The R-C time constant of R_{IN} and the diode capacitance may also slow response time.

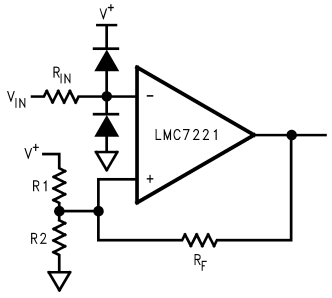


Figure 3.

LAYOUT CONSIDERATIONS

The LMC7221 is not an especially fast comparator, so high speed design practices are not required. The LMC7221 is capable of operating with very high impedance inputs, so precautions should be taken to reduce noise pickup with high impedance (~ 100 kΩ and greater) designs and in electrically noisy environments.

Keeping high value resistors close to the LMC7221 and minimizing the size of the input nodes is a good practice. With multilayer designs, try to avoid long loops which could act as inductors (coils). Sensors which are not close to the comparator may need twisted pair or shielded connections to reduce noise.

PUSH-PULL OUTPUTS, DUAL VERSIONS

The LMC7211 is a comparator similar to the LMC7221, but with push-pull outputs which can source current.

The performance of the LMC7221 is available in a dual device. Please see the LMC6772 datasheet. For a dual device with push-pull outputs, please see the LMC6762 datasheet.

Rail-to-Rail Input Low Power Comparators—

	Push-Pull Output	
LMC7221	5-Pin SOT23, 8-Pin SOIC	Single
LMC6762	8-Pin SOIC	Dual
	Open Drain Output	
LMC7221	5-Pin SOT23, 8-Pin SOIC	Single
LMC6772	8-Pin SOIC	Dual

ADDITIONAL 5-Pin SOT23 TINY DEVICES

National Semiconductor has additional parts available in the space saving SOT23 Tiny package, including amplifiers, voltage references, and voltage regulators, including the following:

LMC7101	1 MHz gain-bandwidth rail-to-rail input and output amplifier—high input impedance and high gain 700 µA typical current 2.7V, 3V, 5V and 15V specifications.
LMC7111	Low power 50 kHz gain-bandwidth rail-to-rail input and output amplifier with 25 µA typical current specified at 2.7V, 3.0V, 3.3V, 5V and 10V.
LM7131	Tiny Video amp with 70 MHz gain bandwidth 3V, 5V and ±5V specifications.
LP2980	Micropower SOT 50 mA Ultra Low-Dropout Regulator.
LM4040	Precision micropower shunt voltage reference. Fixed voltages of 2.500V, 4.096V, 5.000V, 8.192V and 10.000V.
LM4041	Precision micropower shut voltage reference 1.225V and adjustable.
LM385	Low current voltage reference. Fixed Voltages of 1.2V and 2.5V.

Contact your National Semiconductor representative for the latest information.

SPICE MACROMODEL

A Spice Macromodel is available for the LMC7221 comparator on the National Semiconductor Amplifier Macromodel disk. Contact your National Semiconductor representative to obtain the latest version.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LMC7221AIM	ACTIVE	SOIC	D	8	95	TBD	CU SNPB	Level-1-235C-UNLIM	-40 to 85	LMC72 21AIM	Samples
LMC7221AIM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	LMC72 21AIM	Samples
LMC7221AIM5	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 85	C01A	Samples
LMC7221AIM5/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	C01A	Samples
LMC7221AIM5X	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 85	C01A	Samples
LMC7221AIM5X/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	C01A	Samples
LMC7221AIMX	ACTIVE	SOIC	D	8	2500	TBD	CU SNPB	Level-1-235C-UNLIM	-40 to 85	LMC72 21AIM	Samples
LMC7221AIMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	LMC72 21AIM	Samples
LMC7221BIM	ACTIVE	SOIC	D	8	95	TBD	CU SNPB	Level-1-235C-UNLIM	-40 to 85	LMC72 21BIM	Samples
LMC7221BIM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	LMC72 21BIM	Samples
LMC7221BIM5	ACTIVE	SOT-23	DBV	5	1000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 85	C01B	Samples
LMC7221BIM5/NOPB	ACTIVE	SOT-23	DBV	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	C01B	Samples
LMC7221BIM5X	ACTIVE	SOT-23	DBV	5	3000	TBD	CU SNPB	Level-1-260C-UNLIM	-40 to 85	C01B	Samples
LMC7221BIM5X/NOPB	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	C01B	Samples
LMC7221BIMX	ACTIVE	SOIC	D	8	2500	TBD	CU SNPB	Level-1-235C-UNLIM	-40 to 85	LMC72 21BIM	Samples
LMC7221BIMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	LMC72 21BIM	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

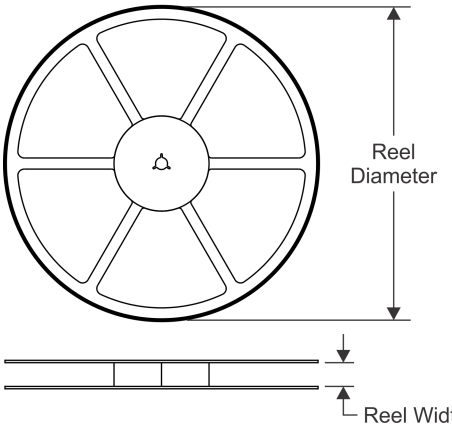
(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

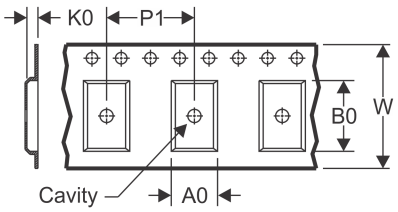
(4) Only one of markings shown within the brackets will appear on the physical device.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

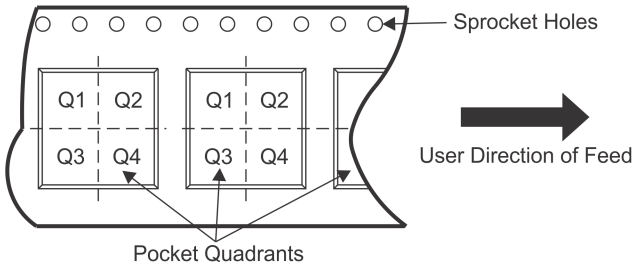


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

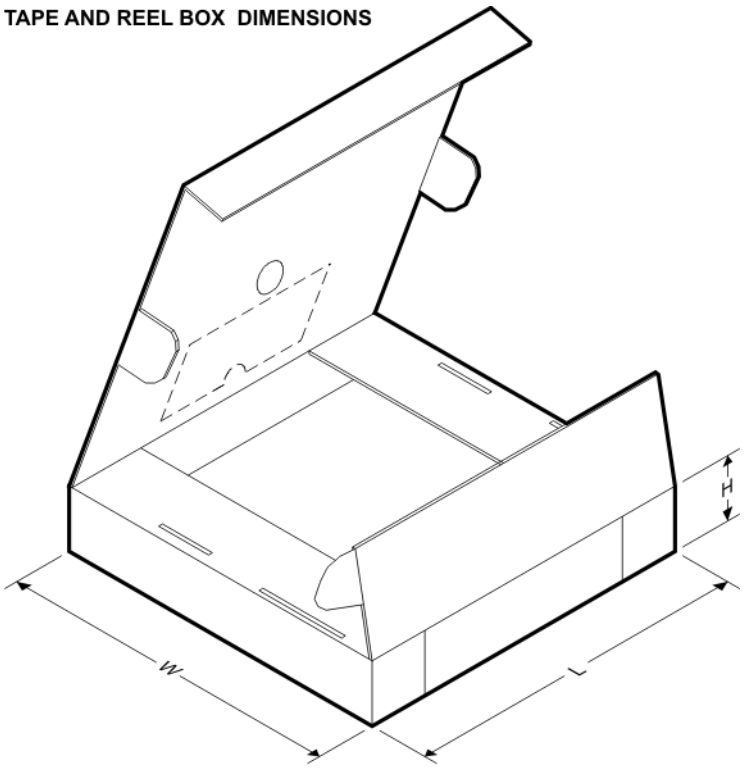
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMC7221AIM5	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMC7221AIM5/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMC7221AIM5X	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMC7221AIM5X/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMC7221AIMX	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LMC7221AIMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LMC7221BIM5	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMC7221BIM5/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMC7221BIM5X	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMC7221BIM5X/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMC7221BIMX	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LMC7221BIMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1

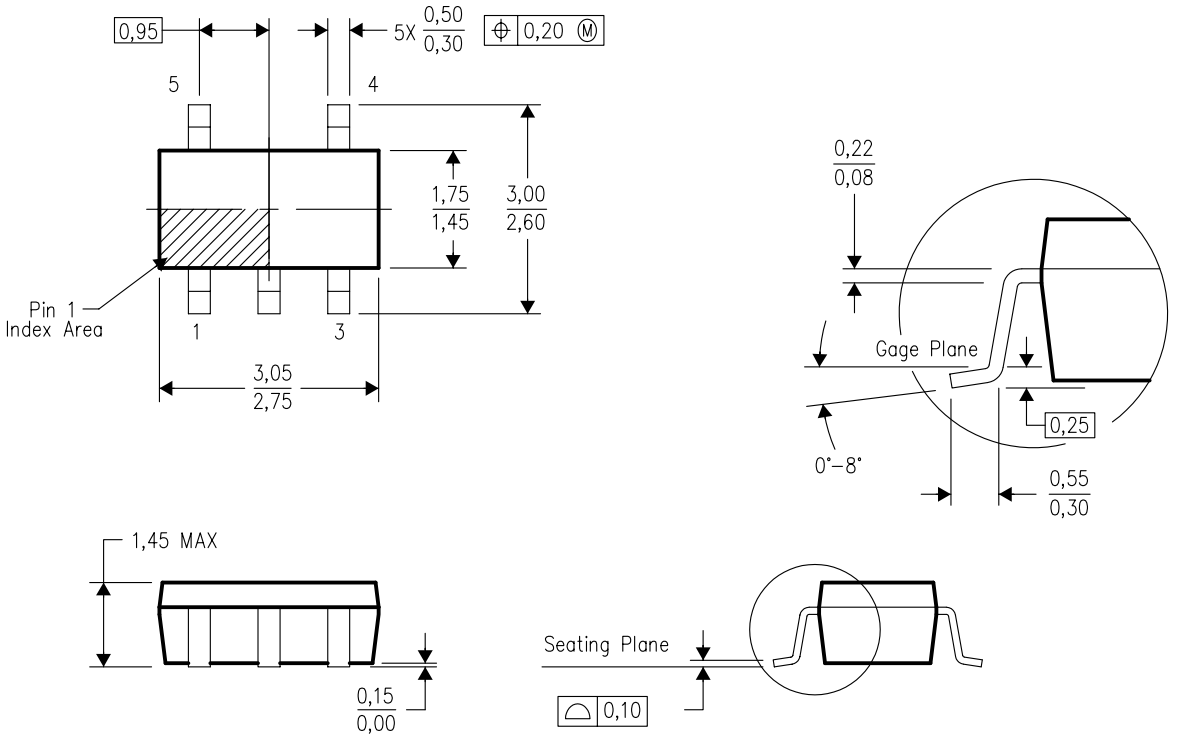
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMC7221AIM5	SOT-23	DBV	5	1000	203.0	190.0	41.0
LMC7221AIM5/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LMC7221AIM5X	SOT-23	DBV	5	3000	206.0	191.0	90.0
LMC7221AIM5X/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LMC7221AIMX	SOIC	D	8	2500	349.0	337.0	45.0
LMC7221AIMX/NOPB	SOIC	D	8	2500	349.0	337.0	45.0
LMC7221BIM5	SOT-23	DBV	5	1000	203.0	190.0	41.0
LMC7221BIM5/NOPB	SOT-23	DBV	5	1000	203.0	190.0	41.0
LMC7221BIM5X	SOT-23	DBV	5	3000	206.0	191.0	90.0
LMC7221BIM5X/NOPB	SOT-23	DBV	5	3000	206.0	191.0	90.0
LMC7221BIMX	SOIC	D	8	2500	349.0	337.0	45.0
LMC7221BIMX/NOPB	SOIC	D	8	2500	349.0	337.0	45.0

DBV (R–PDSO–G5) PLASTIC SMALL–OUTLINE PACKAGE



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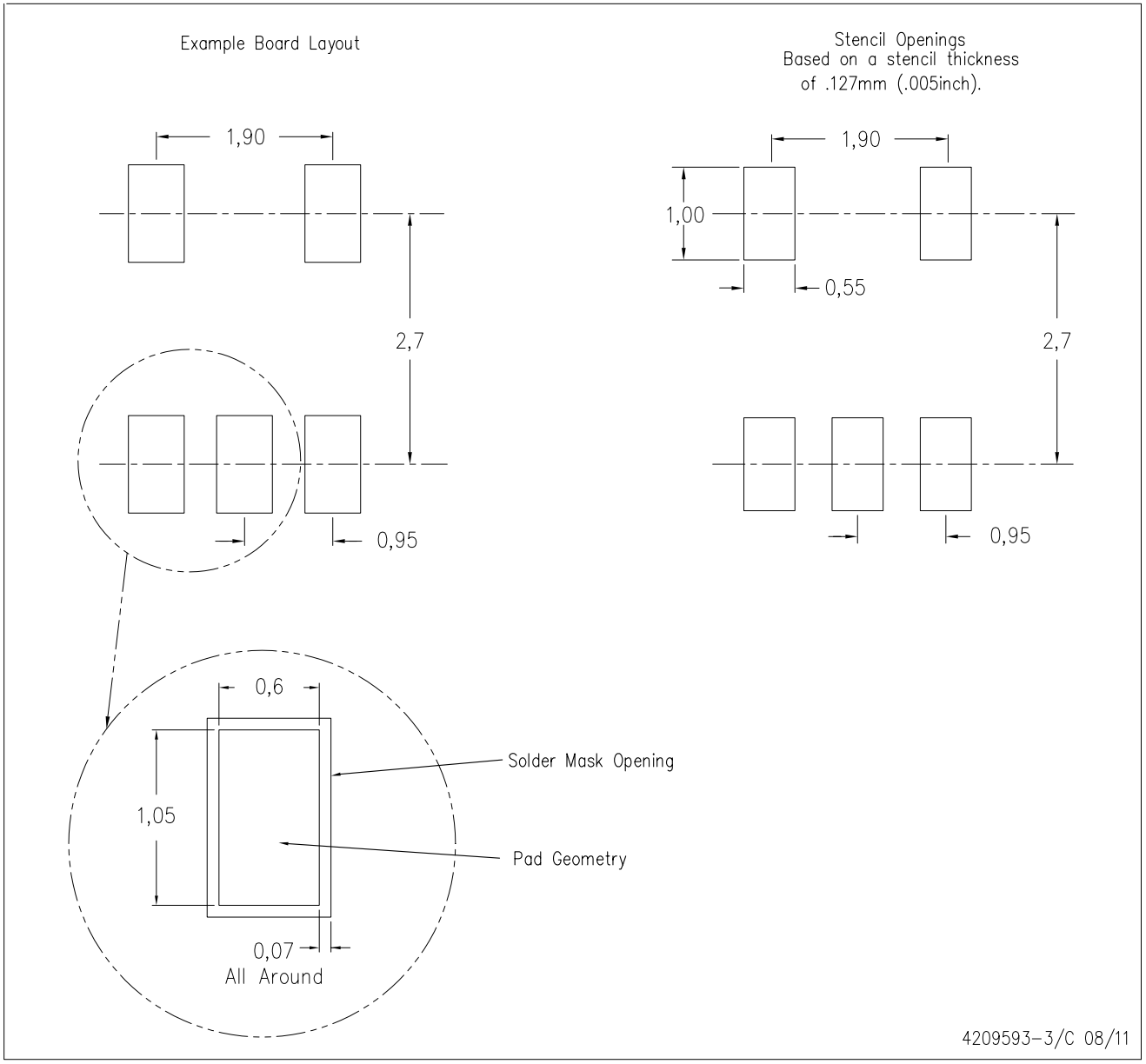
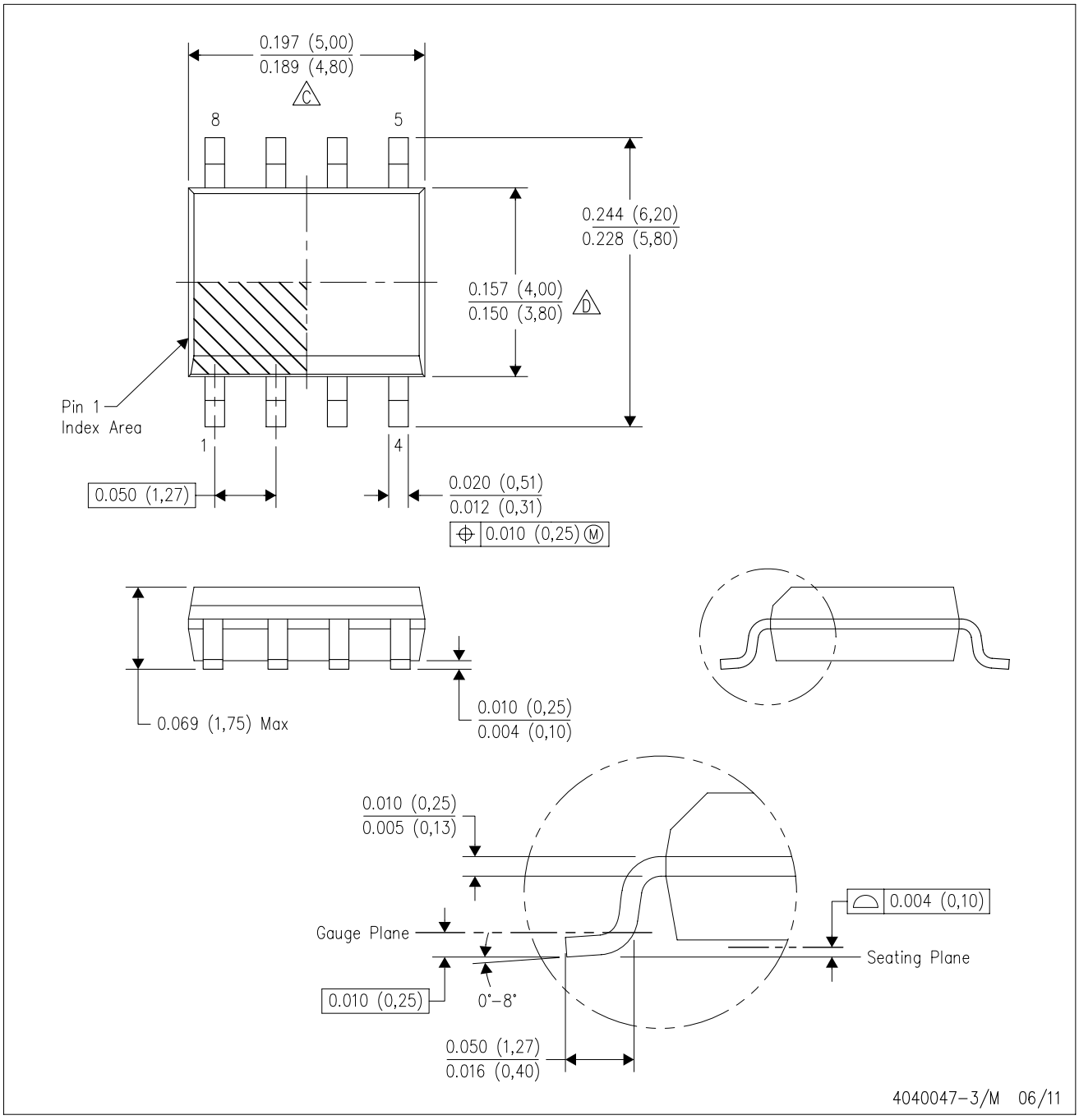
NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
D. Falls within JEDEC MO–178 Variation AA.

DBV (R–PDSO–G5) PLASTIC SMALL OUTLINE



NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
D. Publication IPC–7351 is recommended for alternate designs.
E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC–7525 for other stencil recommendations.

D (R–PDSO–G8) PLASTIC SMALL OUTLINE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AA.

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